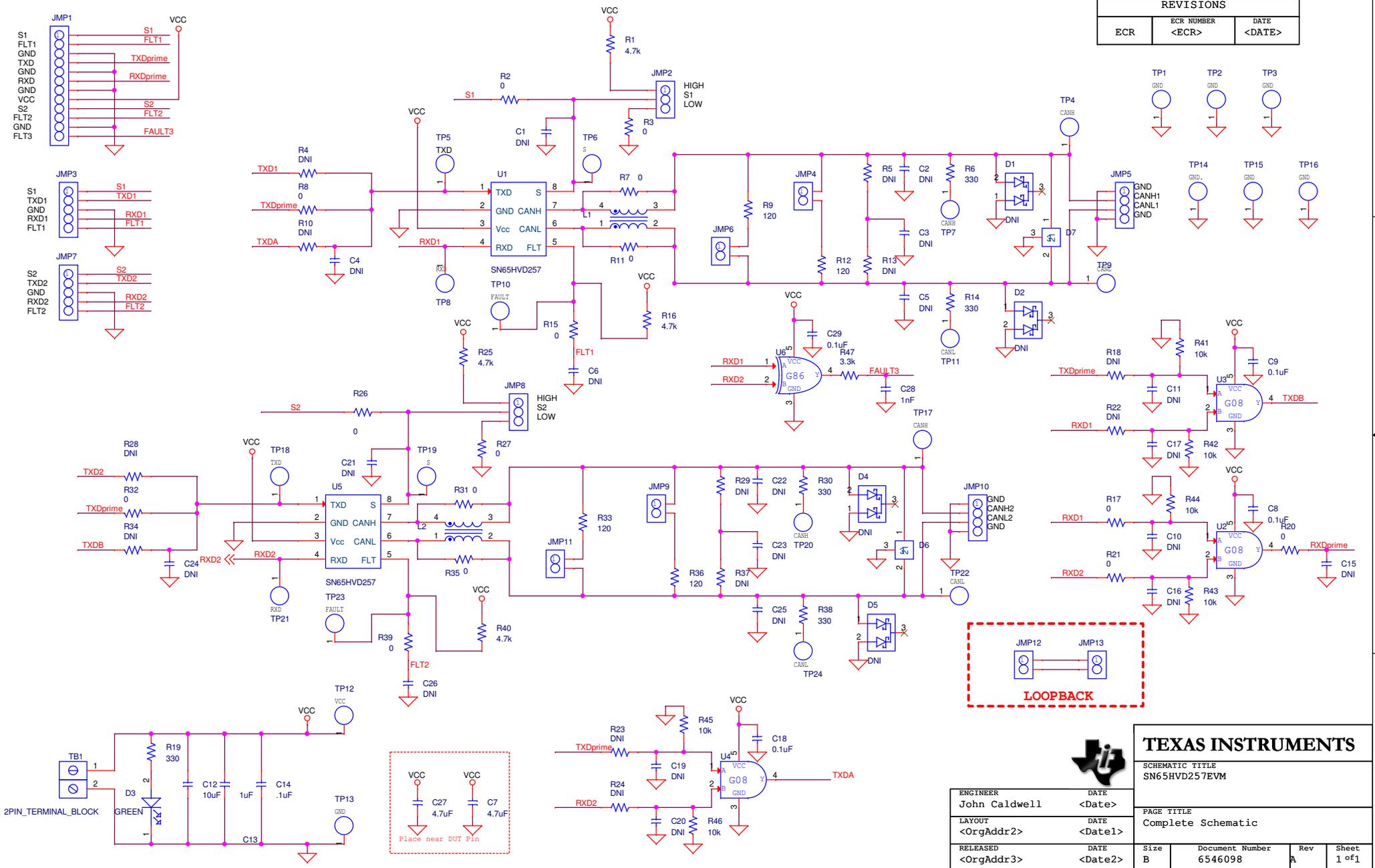


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TEXAS INSTRUMENTS

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SN65HVD257EVM

ENGINEER John Caldwell	DATE <Date>
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